

N-Channel 30-V (D-S) MOSFET

FEATURES

$R_{DS(ON)} \leq 6\text{m}\Omega @ V_{GS}=10\text{V}$

$R_{DS(ON)} \leq 8\text{m}\Omega @ V_{GS}=4.5\text{V}$

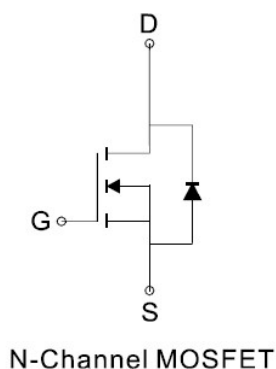
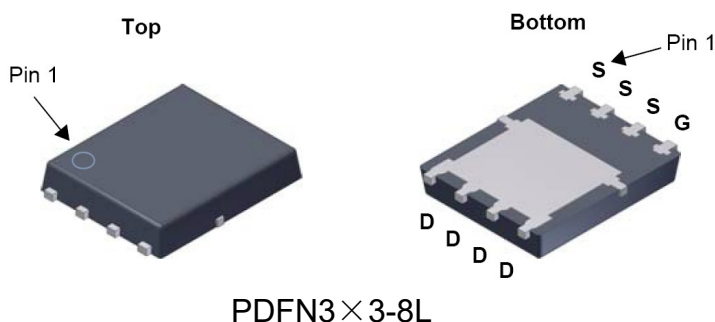
high density cell design for extremely low $R_{DS(ON)}$

Exceptional on-resistance and maximum DC current capability

GENERAL DESCRIPTION

The FS4478 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

PIN CONFIGURATION



Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current($T_J = 150^\circ\text{C}$)*	I_D	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
Pulsed Drain Current	I_{DM}	120	A
Maximum Power Dissipation*	PD	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
Operating Junction Temperature	T_J	-55 to 150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient*	$R_{\theta JA}$	50	$^\circ\text{C/W}$
Thermal Resistance-Junction to Lead*	$R_{\theta JL}$	24	

* The device mounted on 1in² FR4 board with 2 oz copper

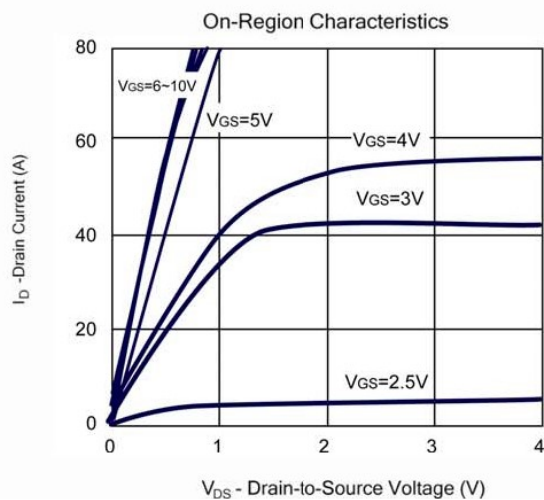
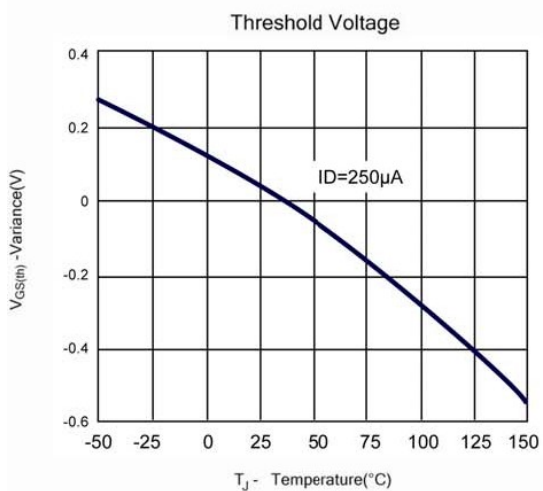
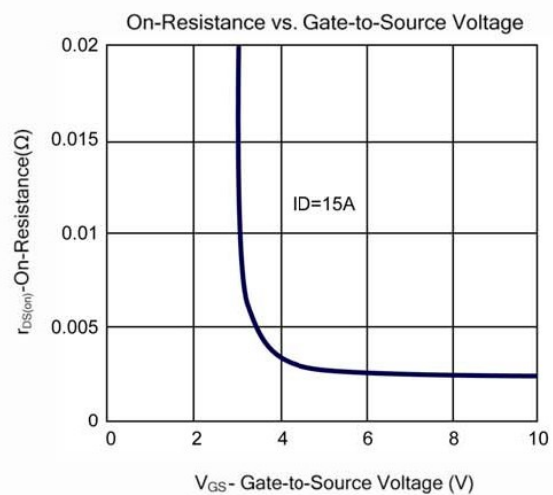
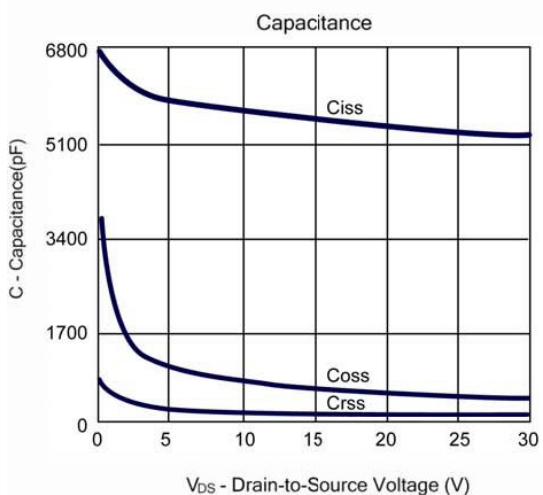
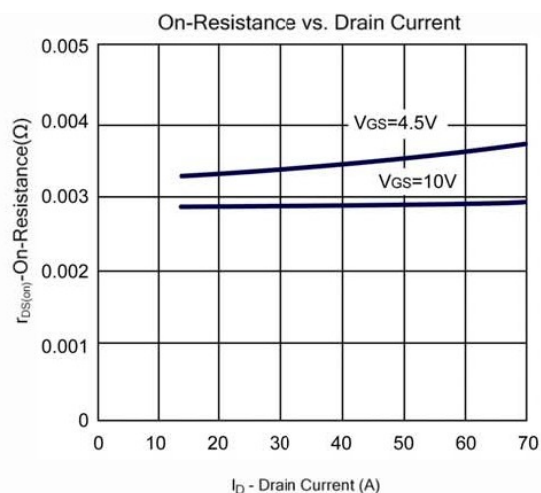
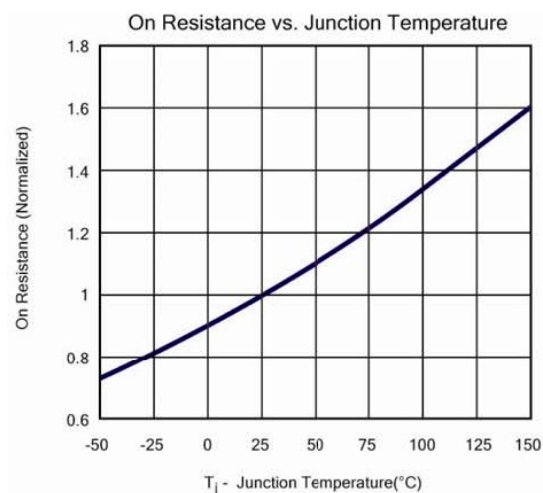


● **Electrical Characteristics** ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.55		2.7	V
IGSS	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
IDSS	Zero Gate Voltage Drain Current	$V_{DS}=30V, V_{GS}=0V$			1	μA
RDS(ON)	Drain-Source On-State Resistance a	$V_{GS}=10V, I_D=10A$		4.6	6.0	m Ω
		$V_{GS}=4.5V, I_D=7.5A$		6.7	8.0	
VSD	Diode Forward Voltage	$I_S=2.7A, V_{GS}=0V$		0.72	1.1	V
DYNAMIC						
Qg	Total Gate Charge(10V)	$V_{DS}=15V, V_{GS}=10V, I_D=17A$		55		nC
Qg	Total Gate Charge(4.5V)	$V_{DS}=15V, V_{GS}=4.5V, I_D=17A$		29		
Qgs	Gate-Source Charge			10		
Qgd	Gate-Drain Charge			15		
Ciss	Input capacitance	$V_{DS}=15V, V_{GS}=0V, f=1.0MHz$		3200		pF
Coss	Output Capacitance			550		
Crss	Reverse Transfer Capacitance			210		
Rg	Gate-Resistance	$V_{DS}=0V, V_{GS}=0V, f=1MHz$		1.2		Ω
td(on)	Turn-On Delay Time	$V_{DD}=15V, R_L=15\Omega, I_D=1A, V_{GEN}=10V, R_G=6\Omega$		23		ns
tr	Turn-On Rise Time			12		
td(off)	Turn-Off Delay Time			86		
tf	Turn-Off Fall Time			12		

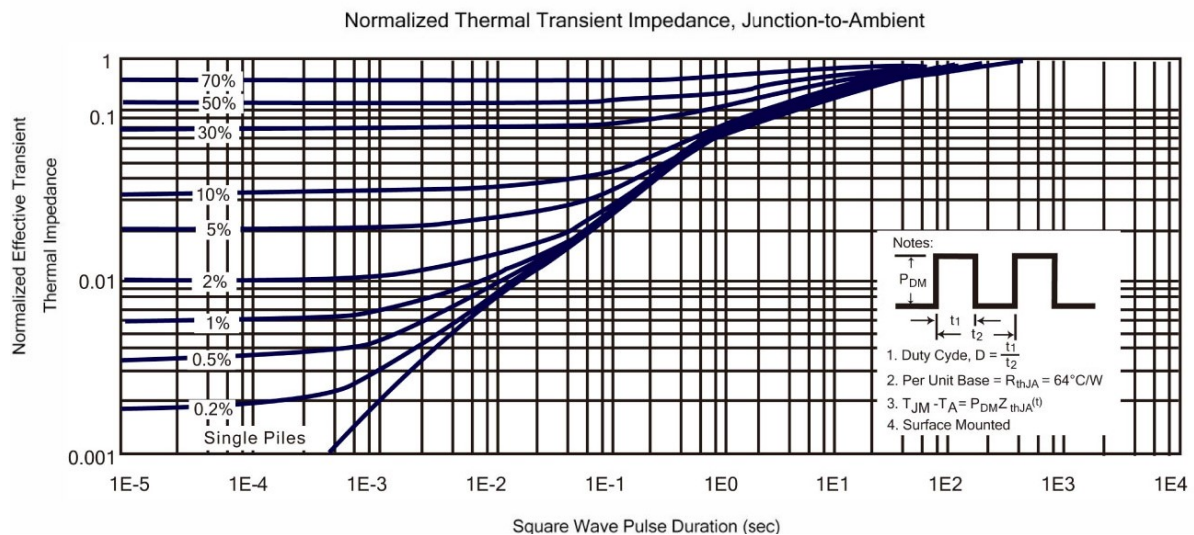
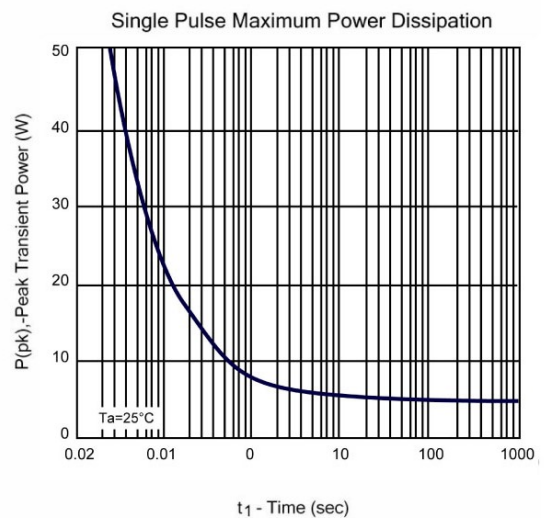
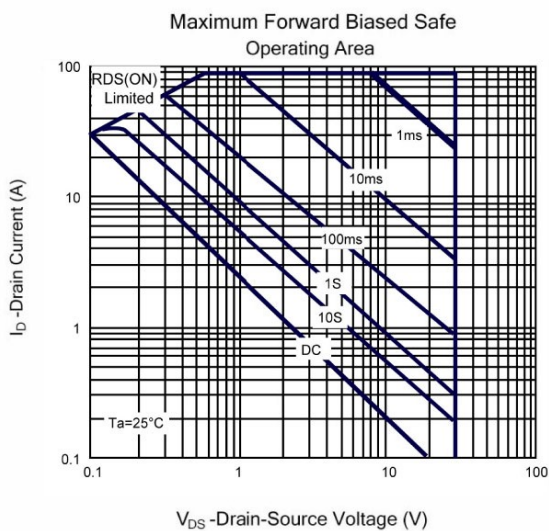
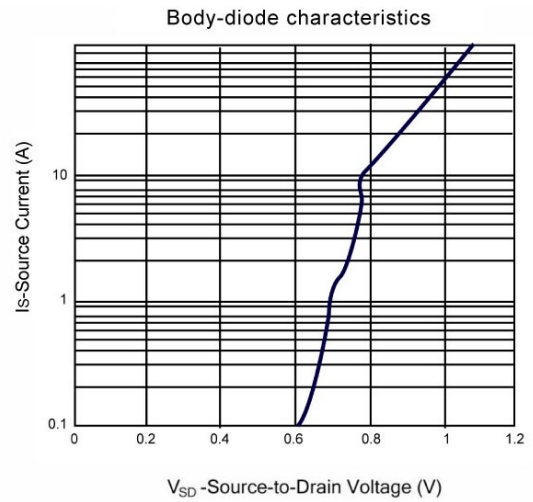
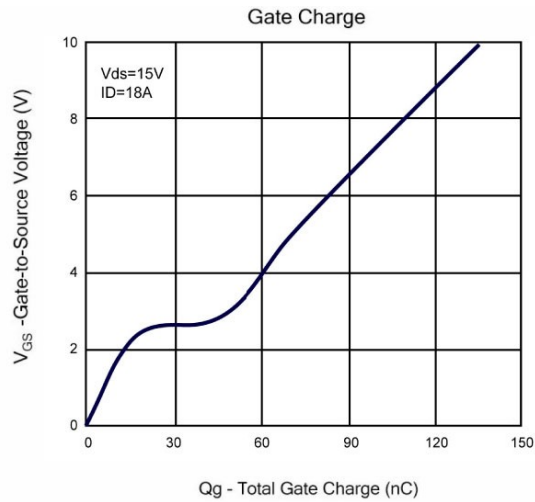
Note:

- A. The value of R_{qJA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The Power dissipation PDSM is based on $R_{qJA} \leq 10s$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.
- B. The power dissipation PD is based on $T_J(MAX)=150^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- C. Single pulse width limited by junction temperature $T_J(MAX)=150^{\circ}\text{C}$.
- D. The R_{qJA} is the sum of the thermal impedance from junction to case R_{qJC} and case to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using $<300ms$ pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_J(MAX)=150^{\circ}\text{C}$. The SOA curve provides a single pulse rating.
- G. The maximum current rating is package limited.
- H. These tests are performed with the device mounted on 1 in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$.



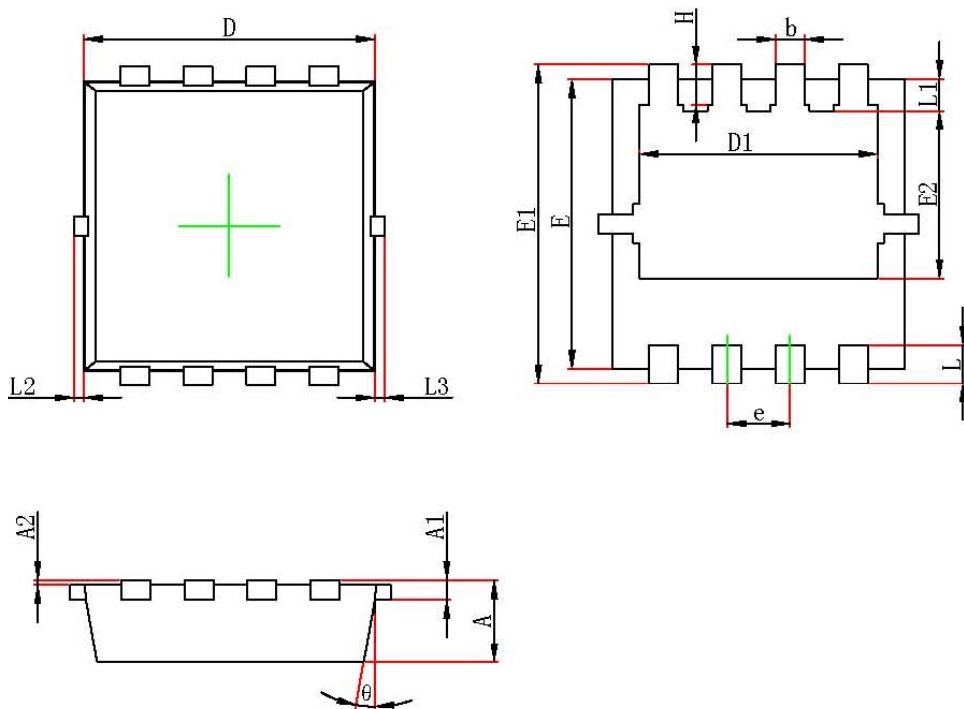


● TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





● PACKAGE PDFN3×3-8L



DFN3030-8L: mm			
Dim	Min	Max	Typ
A	0.65	0.85	0.75
A1	0.152Ref.		
A2	0	0.05	0.03
D	2.90	3.10	3.00
D1	2.24	2.54	2.39
E	2.90	3.10	3.00
E1	3.15	3.45	3.30
E2	1.23	1.64	1.43
e	0.55	0.75	0.65
b	0.20	0.40	0.30
L	0.30	0.50	0.40
L1	0.18	0.48	0.33
L2	0	0.10	0.05
L3	0	0.10	0.05
H	0.31	0.52	0.42
θ	9°	13°	11°